Conductive polymer chip capacitors (Bottom surface electrode type : Large capacitance)

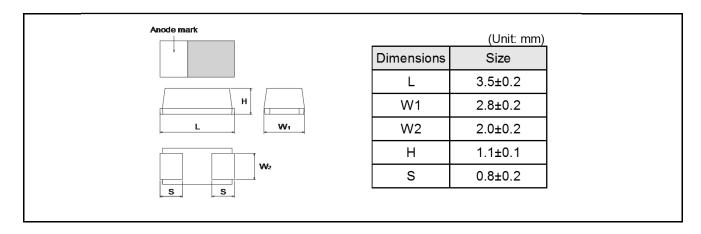
TCTO Series BL Case

Datasheet

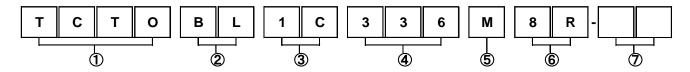
Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) Bottom electrode configuration results in the largest capacitance.
- 3) Compact, low profile, high capacitance contribute to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

Dimensions



● Part No. Explanation



- ① Series name TCTO
- ② Case style BL: 3528-12 (1411) size

Rated voltage

Rated voltage (V)	2	2.5	4	6.3	10	16	25	35
CODE	0D	0E	0G	0J	1A	1C	1E	1V

- Nominal capacitance
 Nominal capacitance in pF in 3 digits:
 2 significant figures followed by the figure representing the number of 0's.
- ⑤ Capacitance tolerance

M: ±20%

6 Taping

1/5

- 8: Tape width
- R: Positive electrode on the side opposite to sprocket hole
- ⑦ Discrimination code

^{*}This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

Rated table

 $(ESR : m\Omega)$

Capacitance				Rated volta	age (V.DC)			
(μF)	2	2.5	4	6.3	10	16	25	35
6.8 (685)								150
10 (106)							☆ 100	☆150
15 (156)							100	
22 (226)							☆ 100	
33 (336)						70		
47 (476)					☆70	☆ 70		
100 (107)				☆25/☆35				
150 (157)				25 / 35				
220 (227)				☆25/☆35				
330 (337)		☆15	☆25/☆35/ ☆45					
470 (477)	☆15	_		_	_	_	_	_

Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

Voltage Code	Rated DC Voltage (V)				
d	2				
е	2.5				
g	4				
j	6.3 10				
Α					
С	16				
E	25				
V	35				

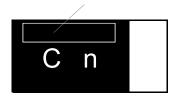
Capacitance Code	Nominal					
Supusiturios Sous	Capacitance (μF)					
W	6.8					
а	10					
е	15					
j	22 33 47					
n						
S						
а	100					
e	150					
j	220					
n	330					
S	470					

[A case]

EX.)

 $\frac{C}{(1)}$ $\frac{n}{(2)}$

(1) voltage code (2) capacitance code



Manufacture code

Characteristics

ltem					Perfor	man	се				ions (based on JIS C 510	· · · · · · · · · · · · · · · · · · ·					
Operating Temp		–55°	°C to	+1	05°C					Voltage reduction when	temperature exceeds +85	5°C					
Maximum opera with no voltage	ting temperature derating	+85	°C														
Rated voltage (\	/.DC)	2	2.5	4	6.3	10	16	25	35	at 85°C							
Category voltage	e (V.DC)	1.6	2	3.:	.2 5	8	12.8	20	25	at 105°C							
Surge voltage (\	/.DC)	2.6 3.2 5 8 13 20 29 40						29	40	at 85°C							
DC Leakage current		Standard list "								As per 4.9 JIS C 5101-1 As per 4.5.1 JIS C 5101-3 Voltage : Rated voltage for 5min							
Capacitance tolerance			±20%						je.	As per 4.7 JIS C 5101-1 As per 4.5.2 JIS C 5101-3 Measuring frequency : 120 ± 12Hz Measuring voltage : 0.5Vrms + 1.5V.DC Measuring circuit : DC Equivalent series circuit							
Tangent of loss angle (Df, $\tan \delta$)			Shall be satisfied the voltage on " Standard list "						"	As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency : 120 ± 12Hz Measuring voltage : 0.5Vrms + 1.5V.DC Measuring circuit : DC Equivalent series circuit							
ESR		Standard list "						n "		As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency : 100 ± 10kHz Measuring voltage : 0.5Vrms or less Measuring circuit : DC Equivalent series circuit							
Resistance to Soldering heat	Appearance	There should be no significant abnormality. The indications should be clear.							uld	As per 4.14 JIS C 5101-1 As per 4.6 JIS C 5101-3 Dip in the solder bath							
	L.C.	Less than 150% of initial limit Within ±20% of initial value Less than 150% of initial limit						it		Solder temp : 240 ± 5°C Duration : 10 ± 0.5s Repetition : 1 After the specimens, leave it at room temperature for over 24h and then measure							
	⊿c/c																
	Df (tan δ)							it		the sample.							
Temperature cycle	Appearance	abnormality. The indications should be clear.							uld	As per 4.16 JIS C 5101- As per 4.10 JIS C 5101- Repetition : 5 cycles (1 cycle : steps 1 to 4) v	-3 vithout discontinuation.	Time					
					ess than 500% of initial limit				Temp.	TILLIG							
	L.C.	Less	s thar	n 5	00% o	finiti	al lim	it		1	−55±3°C	30±3min.					
	L.C.	Less	s thai	n 5	00% o	f initi	al lim	it		1 2	−55±3°C Room temp.	30±3min. 3min. or less					
	L.C.	Less	s thar	n 5	00% o	f initi	al lim	it 									
	L.C. ⊿C/C				600% o			it		3 4	Room temp. 105±2°C Room temp.	3min. or less 30±3min. 3min. or less					
		With	nin ±2	20%		tial v	alue			3 4	Room temp. 105±2°C Room temp.	3min. or less 30±3min.					
Moisture resistance	⊿c/c	With Less	nin ±2 s thar	20% n 1: lity	% of ini	tial v	alue al lim nifica	it nt	uld	2 3 4 After the specimens, leathe sample. As per 4.22 JIS C 5101 As per 4.12 JIS C 5101	Room temp. 105±2°C Room temp. ave it at room temperature	3min. or less 30±3min. 3min. or less					
	⊿C / C Df (tan δ)	With Less	nin ±2 s than re sh orma clear.	20% n 1: loul	% of ini 50% o	tial v f initi o sig	alue al lim nifica	it nt sho	uld	2 3 4 After the specimens, lead the sample. As per 4.22 JIS C 5101 As per 4.12 JIS C 5101 After leaving the sample humidity are 40±2°C an	Room temp. 105±2°C Room temp. ave it at room temperature -1 -3 e under such atmospheric d 90 to 95% RH, respecti	3min. or less 30±3min. 3min. or less e for over 24h and then measure condition that the temperature an vely, for 500±12h leave it at room					
	⊿C / C Df (tan δ) Appearance	With Less	s than re sh orma clear. s than	n 1: noul llity	% of ini 50% o Id be n	tial v f inition o sign dica	alue al lim nifica	nt sho	uld	2 3 4 After the specimens, lead the sample. As per 4.22 JIS C 5101 As per 4.12 JIS C 5101 After leaving the sample humidity are 40±2°C an	Room temp. 105±2°C Room temp. ave it at room temperature 1 3 e under such atmospheric	3min. or less 30±3min. 3min. or less e for over 24h and then measure condition that the temperature an vely, for 500±12h leave it at room					

	em	Performance	Test conditions (based on JIS C 5101–1 and JIS C 5101–3)						
Temperature	Temp.	−55°C	As per 4.29 JIS C 5101-1						
Stability	⊿c/c	Within 0/–20% of initial value	As per 4.13 JIS C 5101-3						
	Df (tan δ)	Shall be satisfied the value on " Standard list "							
	L.C.	-							
	Temp.	+105°C	7						
	⊿c/c	Within +80/0% of initial value	7						
	Df (tan δ)	Shall be satisfied the value on " Standard list "	7						
	L.C.	Less than 1,000% of initial limit	7						
Surge voltage	Appearance	There should be no significant abnormality.	As per 4.26JIS C 5101-1 As per 4.14JIS C 5101-3 Apply the specified surge voltage via the serial resistance of 1kΩ eve 5±0.5 min. for 30±5 s. each time in the atmospheric condition of 85±						
	L.C.	Less than 150% of initial limit							
	⊿c/c	Within ±20% of initial value	C. Repeat this procedure 1,000 times.						
	Df (tan δ)	Less than 150% of initial limit	After the specimens, leave it at room temperature for over 24h and then measure the sample.						
Loading at High temperature	Appearance	There should be no significant abnormality. The indications should be clear.	As per 4.23 JIS C 5101-1 As per 4.15 JIS C 5101-3						
	L.C.	Less than 200% of initial limit	After applying the rated voltage for 1000+72/0 h without discontinuation will the social resistance of 30 or less at a temperature of 85+2°C						
	⊿c/c	Within ±20% of initial value	wia the serial resistance of 3Ω or less at a temperature of 85 \pm 2°C, leave the sample at room temperature / humidity for over 24h and						
	Df (tan δ)	Less than 150% of initial limit	measure the value.						
Terminal strength	, ,	The measured value should be stable.	As per 4.35 JIS C 5101-1						
g			As per 4.9 JIS C 5101-3						
			A force is applied to the terminal until it bends to 1mm and by a prescribed tool maintains the condition for 5s.						
	Appearance	There should be no significant abnormality.	(See the figure below)						
			(Unit: mm)						
			50/20 F (Apply faces)						
			F (Apply force)						
			R230/						
			10001						
			thickness=1.6mm						
			45 45						
A		The terminal about out are a off	A 4 24 110 O 5404 4						
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3						
			Apply force of 5N in the two directions shown in the figure below for						
			±1s after mounting the terminal on a circuit board.						
			product						
			Apply force						
			Apply force						
			a circuit board						
Dimensions		Defer to "External dimensions"							
Dimensions Registered to colv	ronto	Refer to "External dimensions"	Measure using a caliper of JIS B 7507 Class 2 or higher grade.						
Resistance to solv	CIIIO	The indication should be clear.	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3						
			Dip in the isopropyl alcohol for 30±5s, at room temperature.						
Solderability		3/4 or more surface area of the solder coated	As per 4.15.2 JIS C 5101-1						
Solderability		terminal dipped in the soldering bath should be	As per 4.7 JIS C 5101-3						
		covered with the new solder.	Dip speed=25±2.5mm / s						
			Pre-treatment (accelerated aging):						
			Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C						
			Duration: 3±0.5s						
			Solder: M705						
			Flux: Rosin 25% IPA 75%						
Vibration	Capacitance	Measure value should not fluctuate during the	As per 4.17 JIS C 5101-1						
		measurement.	Frequency: 10 to 55 to 10Hz/min.						
	Appearance	There should be no significant abnormality.	Amplitude : 1.5mm Time : 2h each in X and Y directions						

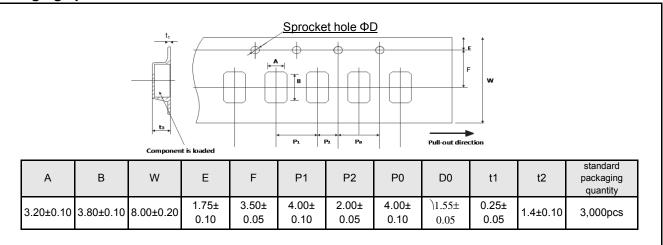


Standard products list

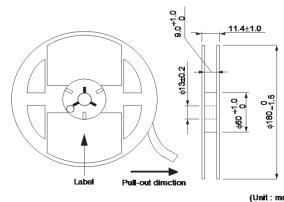
Part No.	Rated voltage 85°C	e voltage voltage		Cap. To	Toleranc e	Leakage current 25° C 1WV.5min	Df 120Hz (%)			ESR 100kHz
	(V)	(V)	(V)	(μF)	(%)	(μA)	–55°C	25°C	105°C	$(m\Omega)$
* TCTO BL 0D 477 M8R-ZE1	2	1.6	2.6	470	±20	94	30	15	20	15
* TCTO BL 0E 337 M8R-ZE1	2.5	2	3.2	330	±20	82.5	30	15	20	15
* TCTO BL 0G 337 M8R-ZK1	4	3.2	5	330	±20	132	30	15	20	25
* TCTO BL 0G 337 M8R-ZN1	4	3.2	5	330	±20	132	30	15	20	35
* TCTO BL 0G 337 M8R-ZS1	4	3.2	5	330	±20	132	30	15	20	45
* TCTO BL 0J 107 M8R-ZK1	6.3	5	8	100	±20	63	8	8	12	25
* TCTO BL 0J 107 M8R-ZN1	6.3	5	8	100	±20	63	8	8	12	35
TCTO BL 0J 157 M8R-ZK1	6.3	5	8	150	±20	94.5	30	15	20	25
TCTO BL 0J 157 M8R-ZN1	6.3	5	8	150	±20	94.5	30	15	20	35
* TCTO BL 0J 227 M8R-ZK1	6.3	5	8	220	±20	139	30	15	20	25
* TCTO BL 0J 227 M8R-ZN1	6.3	5	8	220	±20	139	30	15	20	35
* TCTO BL 1A 476 M8R-ZW1	10	8	13	47	±20	47	8	8	12	70
TCTO BL 1C 336 M8R-ZW1	16	12.8	20	33	±20	52.8	10	10	15	70
* TCTO BL 1C 476 M8R-ZW1	16	12.8	20	47	±20	75.2	10	10	15	70
* TCTO BL 1E 106 M8R-ZB1	25	20	29	10	±20	50	10	10	15	100
TCTO BL 1E 156 M8R-ZB1	25	20	29	15	±20	75	10	10	20	100
* TCTO BL 1E 226 M8R-ZB1	25	20	29	22	±20	110	10	10	20	100
TCTO BL 1V 685 M8R-ZF1	35	25	40	6.8	±20	47.6	10	10	15	150
* TCTO BL 1V 106 M8R-ZF1	35	25	40	10	±20	70	10	10	15	150

^{*} Under development

Packaging specifications



Reel dimensions



(Unit : mm) EIAJ ET-7200A

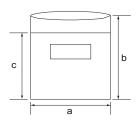
Damp proof package

①One reel is packed in aluminum bag.

The size of aluminum bag is 240(a) x 250(b)mm.

The size up to 230(c)mm is to zipper.

- ②A desiccant is packed with a reel.
- 3The aluminum bag is heat-sealed.
- The label of the same as the label on the reel is placed on the aluminum bag.



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CI ACCIII
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

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